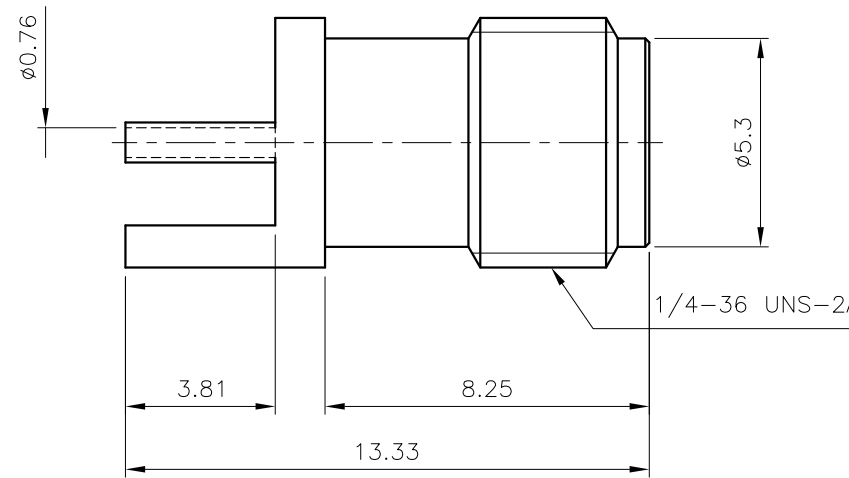
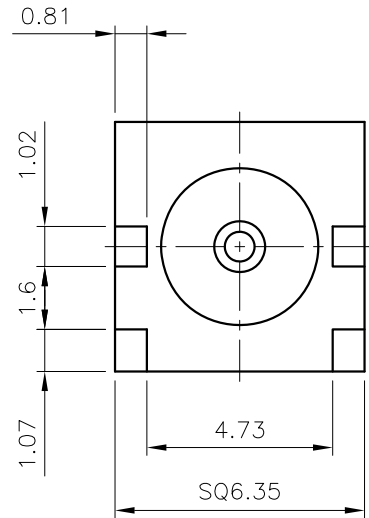


REVISION				
REV	DESCRIPTION	DRAWN	APPR	DATE
1A	Initial Registration	M.H.SONG	I.C.KIM	2013.11.10.
1	[설번처리 No.201508-0001] PUNCH -> HOOK, 내경 및 절연체 변경	S.M.LEE	I.C.KIM	2015.08.06.



* ELECTRICAL DATA :

1. IMPEDANCE : 50Ω (Nominal)
2. FREQUENCY RANGE : DC~6GHz
3. VSWR (Max) : 1.2
4. INSERTION LOSS (Max) : 0.5dB
5. DIELECTRIC WITHSTANDING VOLTAGE : 750V rms
6. INSULATION RESISTANCE : ≥5000MΩ

3	INSULATOR	1	TEFLON		DIN00091-N/1
2	CONTACT	1	BeCu C17300	Gold Plate	DCT00210-5/1
1	BODY	1	MBsBD C3604BD-F	Gold Plate	DBD00310-5/1
NO.	DESCRIPTION	Q'TY	MATERIAL	PLATING	CODE

TOLERANCE	Decimal ±0.1	DATE 2015. 08. 06.			 RF & MICROWAVE TECHNOLOGY Tel : 82-32-347-8015 Fax : 82-32-347-8017
	Angle ±1°	APPROVED BY	I.C.KIM		
MATERIAL _____	CHECKED BY	H.J.LEE			TITLE SMA50 PCB JS-4R(EDGE)
	DRAWN BY	S.M.LEE			
FINISH _____	SCALE 5/1	UNIT mm		A4	DWG NO. CN00172-7/2
					REVISION I R SHEET 1 of 1